

November 21, 2003

To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Fr: George O. Saile Reg. No. 19,572  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

Subject:

**Divisional Patent Application of**  
Serial No.: 09/636,580 8/10/00

SIMON CHOOI, YAKUB ALIYU, MEI-SHENG ZHOU,  
JOHN SUDIJONO, SUBHASH GUPTA, SUDIPTO  
ROY, PAUL HO, XU YI

METHOD TO CREATE A COPPER DIFFUSION  
DETERRENT INTERFACE

#### **PRELIMINARY AMENDMENT**

Dear Sir:

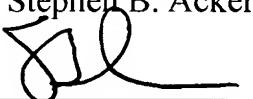
This is a preliminary amendment for the above referenced Divisional Patent Application. Please amend the above identified application for patent as follows:

#### **CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on November 21, 2003.

Stephen B. Ackerman, Reg. No. 37,761

Signature/Date



**PLEASE AMEND THE SPECIFICATION AS FOLLOWS:**

After the title, insert -- This is a division of Patent Application serial number 09/636,580, filing date 8/10/00, Method To Create A Copper Diffusion Detterent Interface, assigned to the same assignee as the present invention.

**REMARKS**

A reference to the parent case has been added by Preliminary Amendment to this Divisional Patent Application.

The application is believed to be in condition for allowance. Allowance of the subject Patent Application is therefore respectfully requested.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "SB".

STEPHEN B. ACKERMAN, REG. NO. 37,761